

BS170 / MMBF170

N-Channel Enhancement Mode Field Effect Transistor

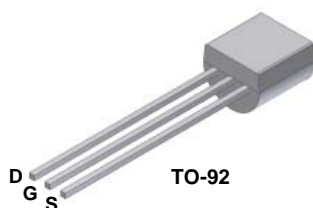
General Description

These N-Channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 500mA DC. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

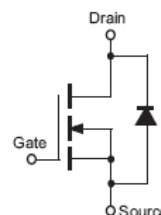
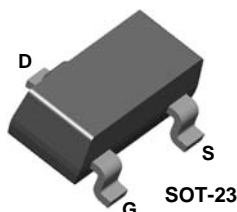
Features

- High density cell design for low $R_{DS(ON)}$.
- Voltage controlled small signal switch.
- Rugged and reliable.
- High saturation current capability.

BS170



MMBF170



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | BS170 | MMBF170 | Units |
|----------------|---|-------------|---------|------------------|
| V_{DSS} | Drain-Source Voltage | 60 | | V |
| V_{DGR} | Drain-Gate Voltage ($R_{GS} \leq 1\text{M}\Omega$) | 60 | | V |
| V_{GSS} | Gate-Source Voltage | ± 20 | | V |
| I_D | Drain Current - Continuous - Pulsed | 500 | 500 | mA |
| | | 1200 | 800 | |
| T_J, T_{STG} | Operating and Storage Temperature Range | - 55 to 150 | | $^\circ\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds | 300 | | $^\circ\text{C}$ |

Thermal Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | BS170 | MMBF170 | Units |
|-----------------|--|-------|---------|---------------------------|
| P_D | Maximum Power Dissipation Derate above 25°C | 830 | 300 | mW |
| | | 6.6 | 2.4 | mW/ $^\circ\text{C}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 150 | 417 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics $T_A=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Type | Min. | Typ. | Max. | Units |
|-------------------------------------|-----------------------------------|---|---------|------|------|------|-------|
| OFF CHARACTERISTICS | | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0V, I _D = 100μA | All | 60 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 25V, V _{GS} = 0V | All | | | 0.5 | μA |
| I _{GSSF} | Gate - Body Leakage, Forward | V _{GS} = 15V, V _{DS} = 0V | All | | | 10 | nA |
| ON CHARACTERISTICS (Notes 1) | | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 1mA | All | 0.8 | 2.1 | 3 | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} = 10V, I _D = 200mA | All | | 1.2 | 5 | Ω |
| g _{FS} | Forward Transconductance | V _{DS} = 10V, I _D = 200mA | BS170 | | 320 | | mS |
| | | V _{DS} ≥ 2 V _{DS(on)} , I _D = 200mA | MMBF170 | | 320 | | |
| Dynamic Characteristics | | | | | | | |
| C _{iSS} | Input Capacitance | V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz | All | | 24 | 40 | pF |
| C _{oSS} | Output Capacitance | | All | | 17 | 30 | pF |
| C _{rSS} | Reverse Transfer Capacitance | | All | | 7 | 10 | pF |
| Switching Characteristics (Notes 1) | | | | | | | |
| t _{on} | Turn-On Time | V _{DD} = 25V, I _D = 200mA, V _{GS} = 10V, R _{GEN} = 25Ω | BS170 | | | 10 | ns |
| | | V _{DD} = 25V, I _D = 500mA, V _{GS} = 10V, R _{GEN} = 50Ω | MMBF170 | | | 10 | |
| t _{off} | Turn-Off Time | V _{DD} = 25V, I _D = 200mA, V _{GS} = 10V, R _{GEN} = 25Ω | BS170 | | | 10 | ns |
| | | V _{DD} = 25V, I _D = 500mA, V _{GS} = 10V, R _{GEN} = 50Ω | MMBF170 | | | 10 | |

Note:

1. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2.0\%$.

Ordering Information

| Part Number | Package | Package Type | Lead Frame | Pin array |
|-------------|---------|---------------|------------|-----------|
| BS170 | TO-92 | BULK | STRAIGHT | D G S |
| BS170_D26Z | TO-92 | Tape and Reel | FORMING | D G S |
| BS170_D27Z | TO-92 | Tape and Reel | FORMING | D G S |
| BS170_D74Z | TO-92 | AMMO | FORMING | D G S |
| BS170_D75Z | TO-92 | AMMO | FORMING | D G S |
| MMBF170 | SOT-23 | Tape and Reel | | |

Typical Electrical Characteristics

BS170 / MMBF170

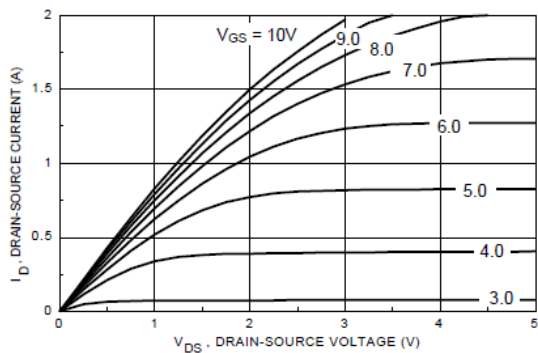


Figure 1. On-Region Characteristics.

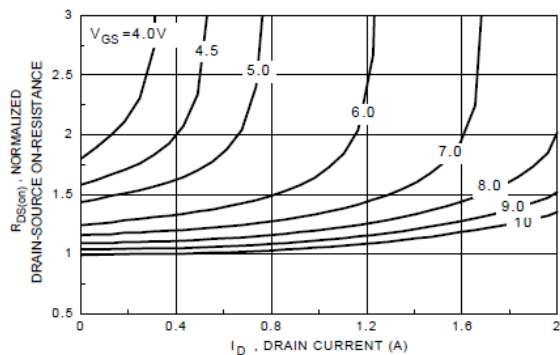


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current.

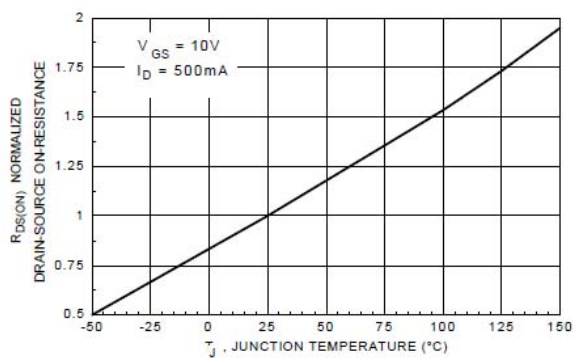


Figure 3. On-Resistance Variation with Temperature.

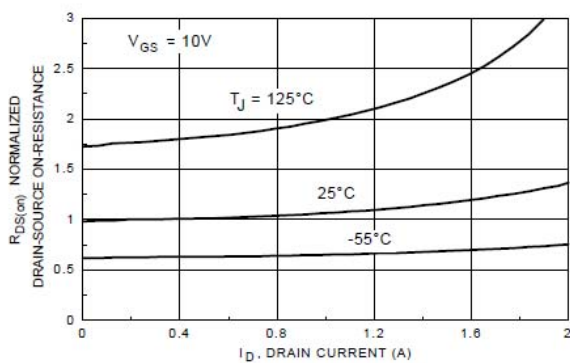


Figure 4. On-Resistance Variation with Drain Current and Temperature.

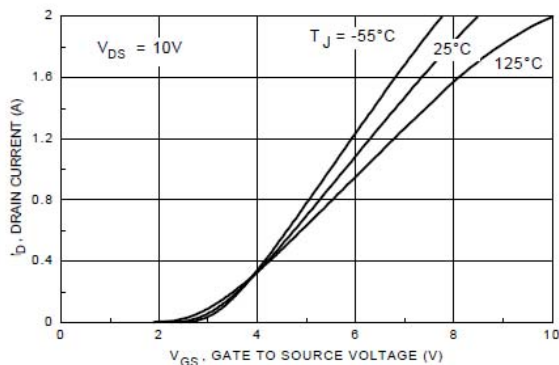


Figure 5. Transfer Characteristics.

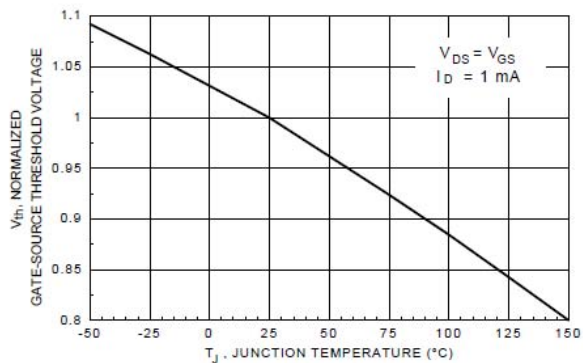


Figure 6. Gate Threshold Variation with Temperature.

Typical Electrical Characteristics (continued)

BS170 / MMBF170

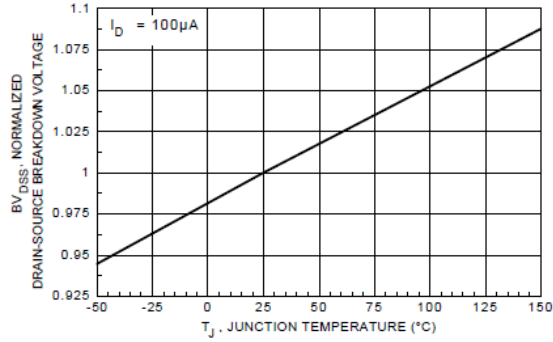


Figure 7. Breakdown Voltage Variation with Temperature.

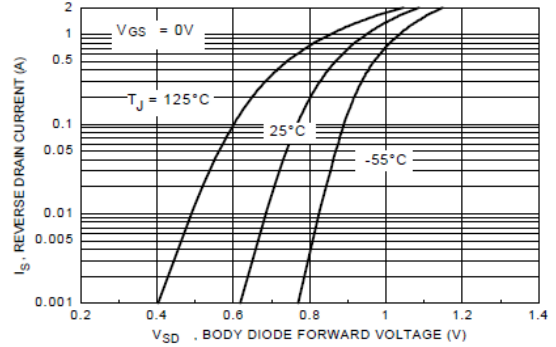


Figure 8. Body Diode Forward Voltage Variation with Current and Temperature.

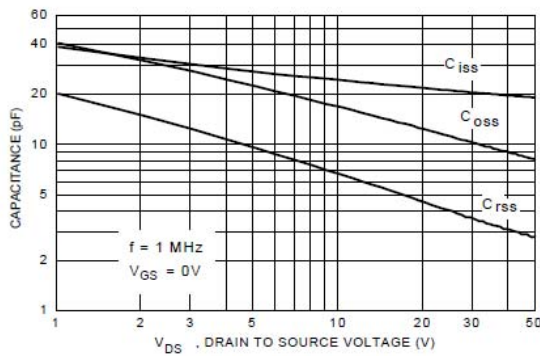


Figure 9. Capacitance Characteristics.

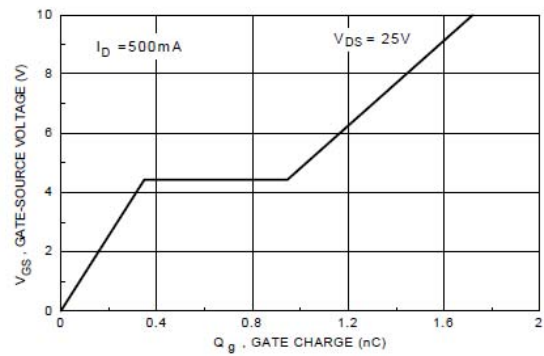


Figure 10. Gate Charge Characteristics.

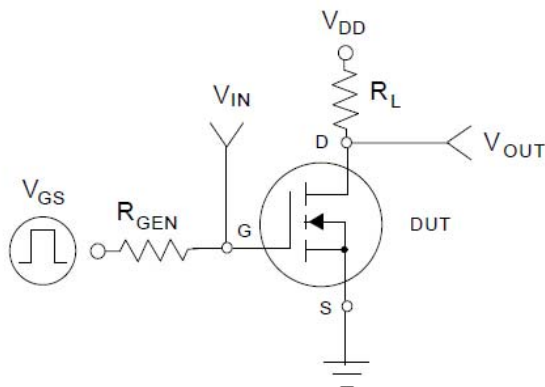


Figure 11. Switching Test Circuit.

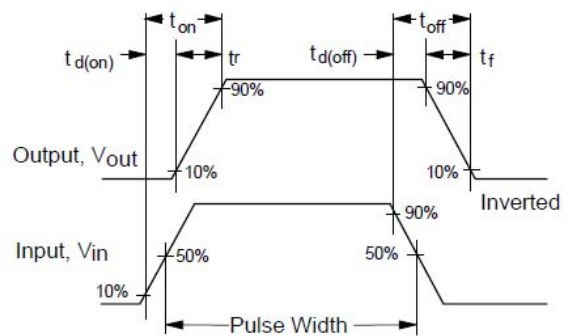


Figure 12. Switching Waveforms.

Typical Electrical Characteristics (continued)

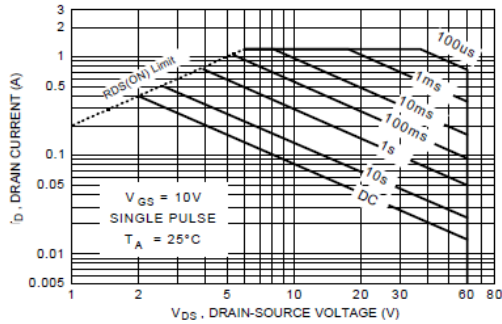


Figure 13. BS170 Maximum Safe Operating Area.

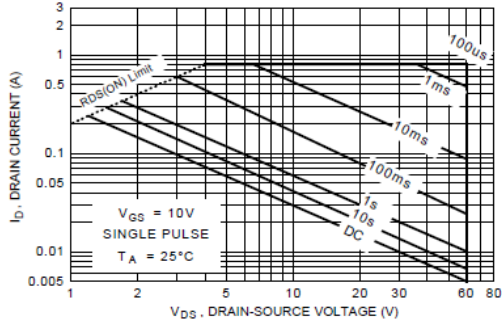


Figure 14. MMBF170 Maximum Safe Operating Area.

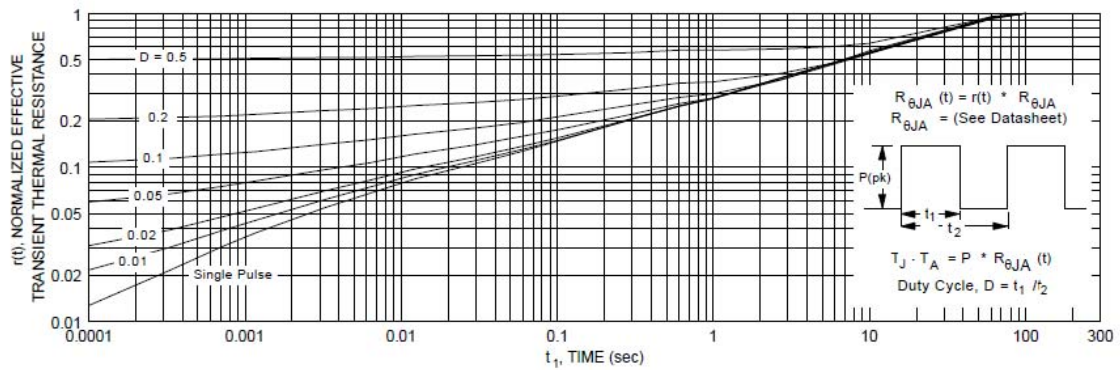


Figure 15. TO-92, BS170 Transient Thermal Response Curve.

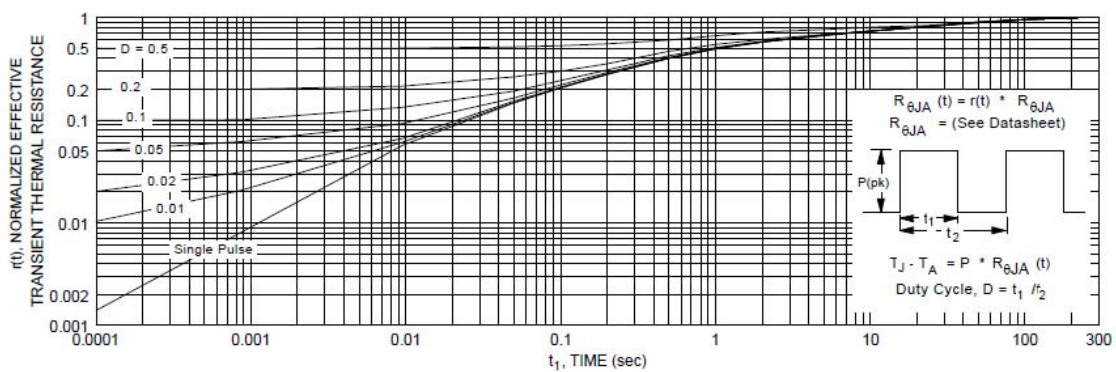
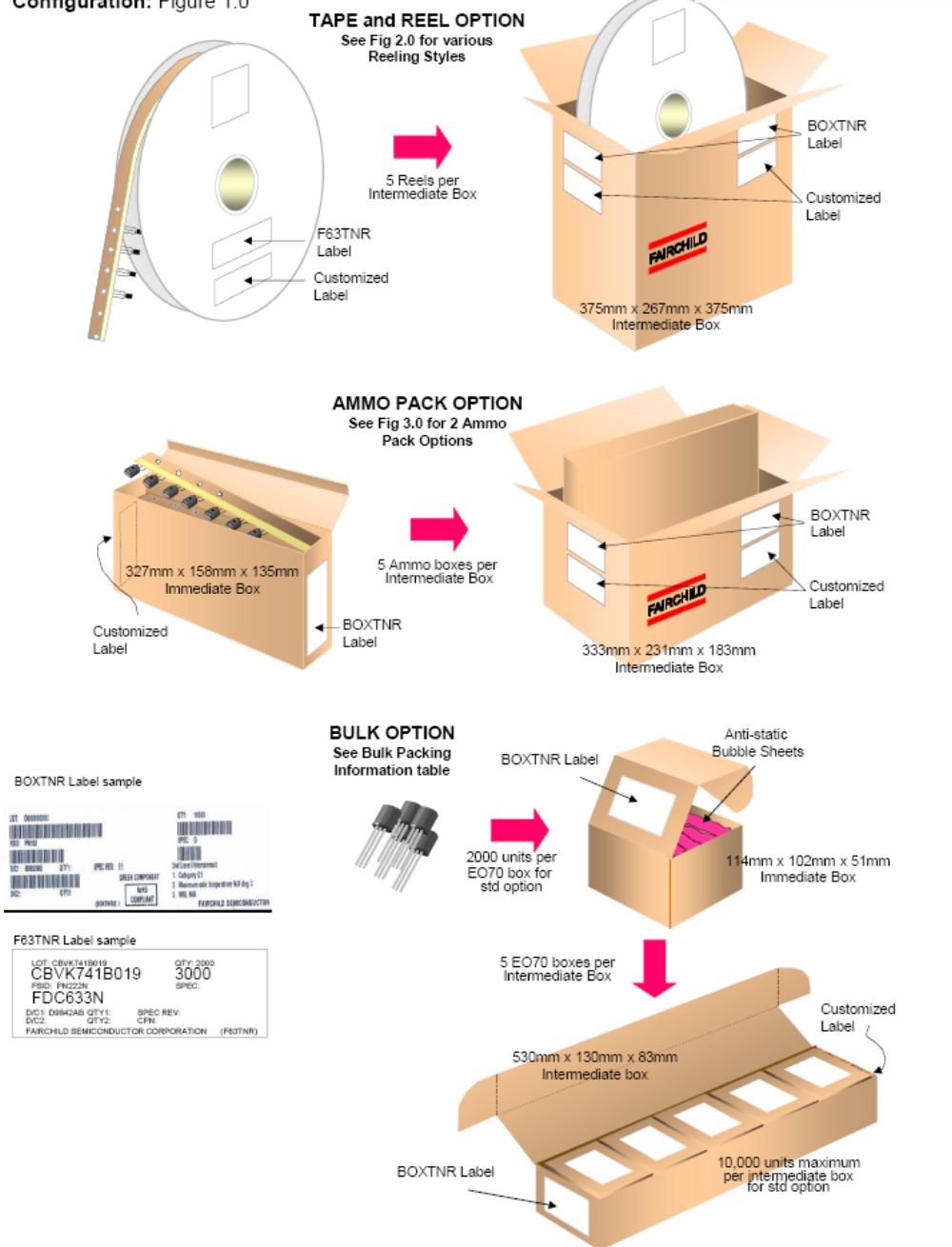


Figure 16. SOT-23, MMBF170 Transient Thermal Response Curve.

TO-92 Tape and Reel Data

TO-92 Packaging
Configuration: Figure 1.0



TO-92 Tape and Reel Data, continued



TO-92 Packing




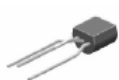

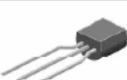
Information: Figure 2.0

TO-92 TNR/AMMO PACKING INFORMATION TABLE

| Packing | Style | Quantity | EOL code |
|---------|-------|----------|----------|
| Reel | A | 2,000 | D26Z |
| | B | 2,000 | D11Z |
| | C | 2,000 | D28Z |
| | D | 2,000 | D10Z |
| | E | 2,000 | D27Z |
| | F | 2,000 | D81Z |
| | G | 2,000 | D29Z |
| | H | 2,000 | D89Z |
| Ammo | M | 2,000 | D74Z |
| | P | 2,000 | D75Z |

Unit weight = 0.22 gm
 Reel weight with components = 1.04 kg
 Ammo weight with components = 1.02 kg
 Max quantity per intermediate box = 10,000 units

TO-92 BULK PACKING INFORMATION TABLE

| EOL CODE / FLOW OPTION | DESCRIPTION | LEADCLIP DIMENSION | MINIMUM ORDER QTY | LEADFORM OUTLINE |
|------------------------|-----------------------|--------------------|-------------------|---|
| NO EOL CODE | STRAIGHT LEADS | NO LEAD CLIP | 2.0K / BOX |  |
| J18Z | TO-18 OPTION STD | NO LEAD CLIP | 2.0K / BOX |  |
| J35Z | TO-18 OPTION REVERSE | NO LEAD CLIP | 2.0K / BOX |  |
| J05Z | TO-5 OPTION STD | NO LEAD CLIP | 1.5K / BOX |  |
| J60Z | TO-5 OPTION REVERSE | NO LEAD CLIP | 1.5K / BOX |  |
| J61Z | IN LINE 0.200 SPACING | NO LEAD CLIP | 1.5K / BOX |  |

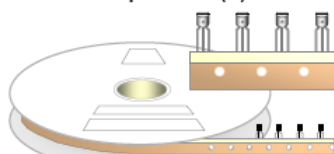
TO-92 Tape and Reel Data, continued

TO-92 Reeling Style

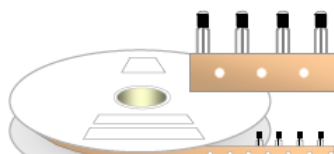
Configuration: Figure 3.0



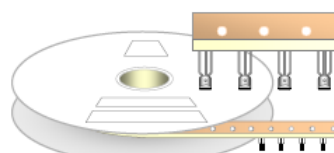
Machine Option "A" (H)



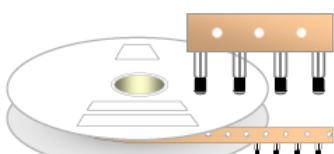
Style "A", D26Z



Style "B", D11Z

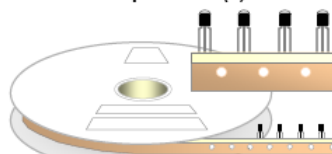


Style "C", D28Z

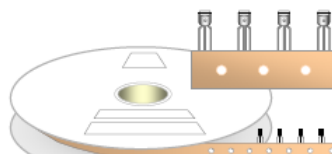


Style "D", D10Z

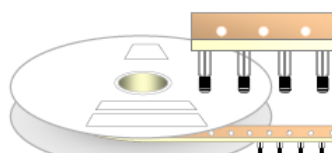
Machine Option "E" (J)



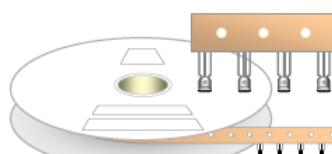
Style "E", D27Z



Style "F", D81Z



Style "G", D29Z

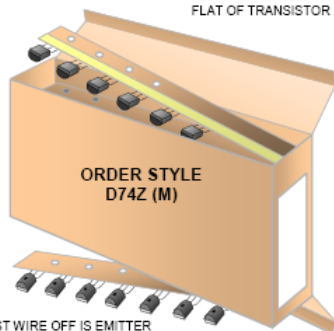


Style "H", D89Z

TO-92 Radial Ammo Packaging

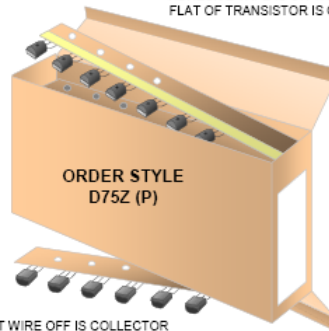
Configuration: Figure 4.0

FIRST WIRE OFF IS COLLECTOR
ADHESIVE TAPE IS ON THE TOP SIDE
FLAT OF TRANSISTOR IS ON TOP



FIRST WIRE OFF IS EMITTER
ADHESIVE TAPE IS ON BOTTOM SIDE
FLAT OF TRANSISTOR IS ON BOTTOM

FIRST WIRE OFF IS EMITTER
ADHESIVE TAPE IS ON THE TOP SIDE
FLAT OF TRANSISTOR IS ON BOTTOM

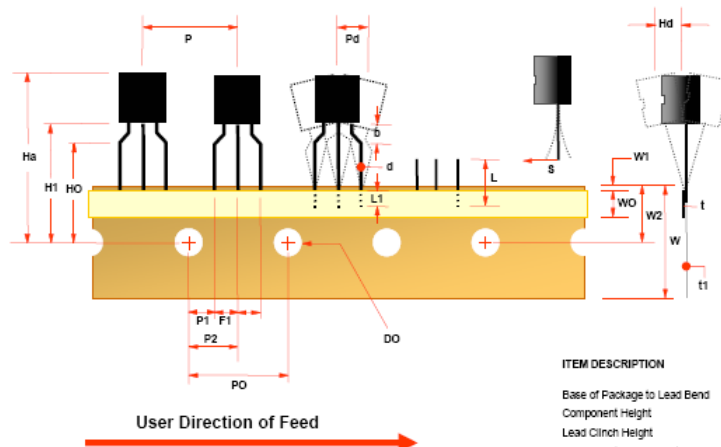


FIRST WIRE OFF IS COLLECTOR
ADHESIVE TAPE IS ON BOTTOM SIDE
FLAT OF TRANSISTOR IS ON TOP

TO-92 Tape and Reel Data, continued

TO-92 Tape and Reel Taping

Dimension Configuration: Figure 5.0

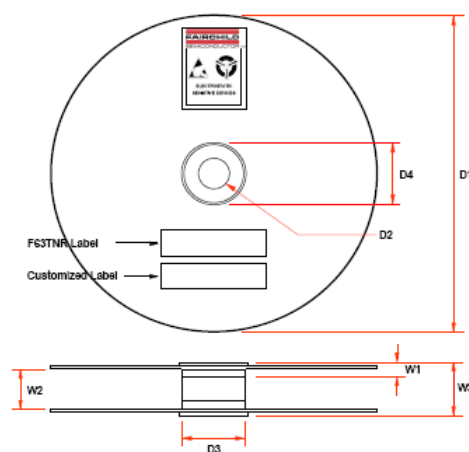


| ITEM DESCRIPTION | SYMBOL | DIMENSION |
|------------------------------------|--------|------------------------|
| Base of Package to Lead Bend | b | 0.098 (max) |
| Component Height | Ha | 0.928 (+/- 0.025) |
| Lead Clinch Height | HO | 0.630 (+/- 0.020) |
| Component Base Height | H1 | 0.748 (+/- 0.020) |
| Component Alignment (side/side) | Pd | 0.040 (max) |
| Component Alignment (front/back) | Hd | 0.031 (max) |
| Component Pitch | P | 0.500 (+/- 0.020) |
| Feed Hole Pitch | PO | 0.500 (+/- 0.008) |
| Hole Center to First Lead | P1 | 0.150 (+0.009, -0.010) |
| Hole Center to Component Center | P2 | 0.247 (+/- 0.007) |
| Lead Spread | F1/F2 | 0.104 (+/- 0.010) |
| Lead Thickness | d | 0.018 (+0.002, -0.003) |
| Cut Lead Length | L | 0.429 (max) |
| Taped Lead Length | L1 | 0.209 (+0.051, -0.052) |
| Taped Lead Thickness | t | 0.032 (+/- 0.006) |
| Carrier Tape Thickness | t1 | 0.021 (+/- 0.006) |
| Carrier Tape Width | W | 0.708 (+0.020, -0.019) |
| Hold - down Tape Width | WO | 0.236 (+/- 0.012) |
| Hold - down Tape position | W1 | 0.035 (max) |
| Feed Hole Position | W2 | 0.360 (+/- 0.025) |
| Sprocket Hole Diameter | DO | 0.157 (+0.008, -0.007) |
| Lead Spring Out | S | 0.004 (max) |

Note : All dimensions are in inches.

TO-92 Reel

Configuration: Figure 6.0

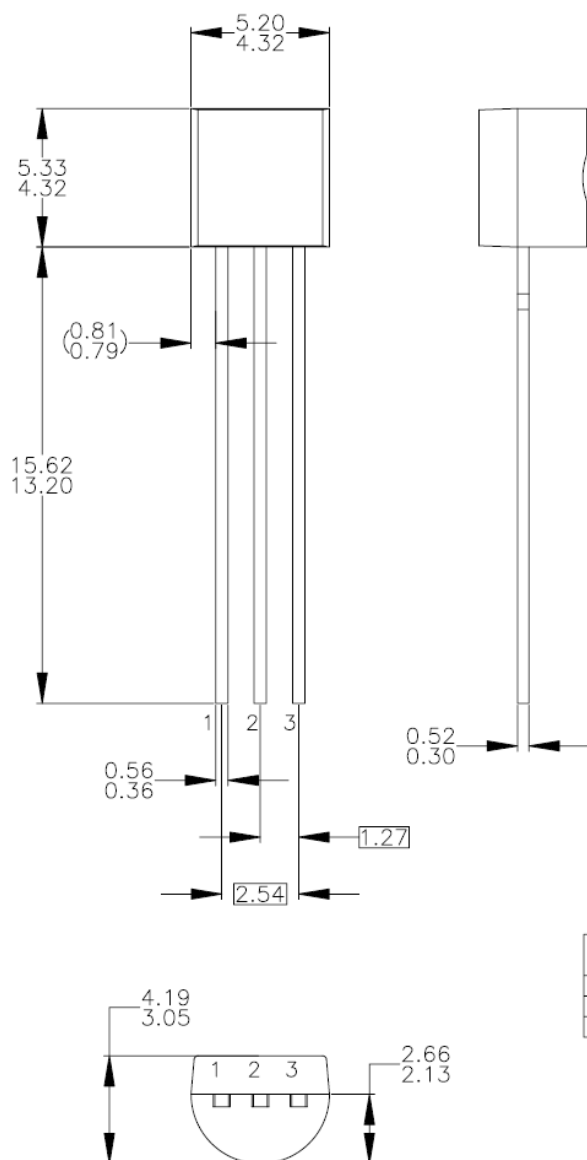


| ITEM DESCRIPTION | SYMBOL | MINIMUM | MAXIMUM |
|--------------------------------|--------|---------|---------|
| Reel Diameter | D1 | 13.975 | 14.025 |
| Arbor Hole Diameter (Standard) | D2 | 1.160 | 1.200 |
| (Small Hole) | D2 | 0.650 | 0.700 |
| Core Diameter | D3 | 3.100 | 3.300 |
| Hub Recess Inner Diameter | D4 | 2.700 | 3.100 |
| Hub Recess Depth | W1 | 0.370 | 0.570 |
| Flange to Flange Inner Width | W2 | 1.630 | 1.690 |
| Hub to Hub Center Width | W3 | | 2.090 |

Note: All dimensions are in inches

Mechanical Dimensions (TO-92)

TO-92



NOTES: UNLESS OTHERWISE SPECIFIED

- A) DRAWING WITH REFERENCE TO JEDEC TO-92 RECOMMENDATIONS.
 B) ALL DIMENSIONS ARE IN MILLIMETERS.
 C) DRAWING CONFORMS TO ASME Y14.5M-1994.
 D) TO-92 (92,94,96,97,98) PIN CONFIGURATION:

| PIN | 92 | | | 94 | | | 96 | | | 97 | | | 98 | | |
|-----|----|---|---|----|---|---|----|---|---|----|---|---|----|---|---|
| | P | F | M | P | F | M | P | F | M | P | F | M | P | F | M |
| 1 | E | S | S | E | S | S | B | D | G | C | G | D | C | G | D |
| 2 | B | D | G | C | G | D | E | S | S | B | D | G | E | S | S |
| 3 | C | G | D | B | D | G | C | G | D | E | S | S | B | D | G |

LEGEND:

P - BIPOLAR E - EMITTER D - DRAIN
 F - JFET B - BASE S - SOURCE
 M - DMOS C - COLLECTOR G - GATE

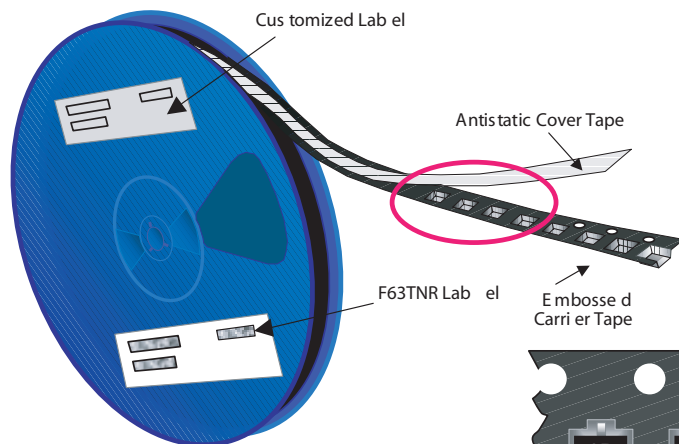
- E) FOR PACKAGE 92, 94, 96, 97 AND 98:
 PIN CONFIGURATION DRAIN "D" AND SOURCE "S"
 ARE INTERCHANGEABLE AT JFET "F" OPTION.
 F) DRAWING FILENAME: MKT-ZA03DREV3.

Dimensions in Millimeters

SOT-23 Std Tape and Reel Data



SOT23-3L Packaging Configuration: Figure 1.0

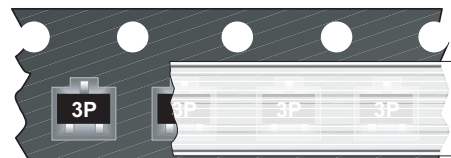


Packaging Description:

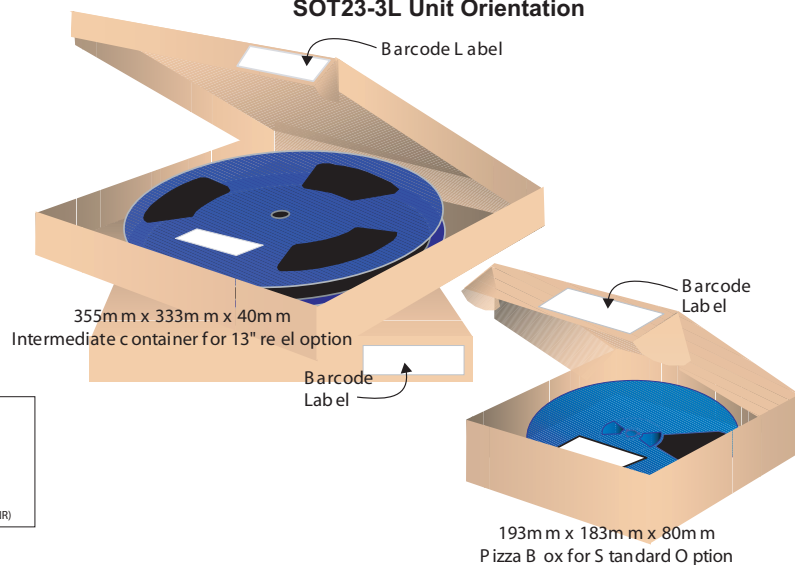
SOT23-3L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177mm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330mm diameter reel. This and some other options are described in the Packaging Information table.

These full reels are individually labeled and placed inside a standard intermediate box made of recyclable corrugated brown paper with a Fairchild logo printing. One box contains five reels maximum. And these intermediate boxes are placed inside a labeled shipping box which comes in different sizes depending on the number of parts shipped.

| SOT23-3L Packaging Information | | |
|--------------------------------|-------------------------|------------|
| Packaging Option | Standard (no flow code) | D87Z |
| Packaging type | TNR | TNR |
| Qty per Reel/Tube/Bag | 3,000 | 10,000 |
| Reel Size | 7" Dia | 13" |
| Box Dimension (mm) | 193x183x80 | 355x333x40 |
| Max qty per Box | 15,000 | 30,000 |
| Weight per unit (gm) | 0.0082 | 0.0082 |
| Weight per Reel (kg) | 0.1175 | 0.4006 |
| Note/Comments | | |



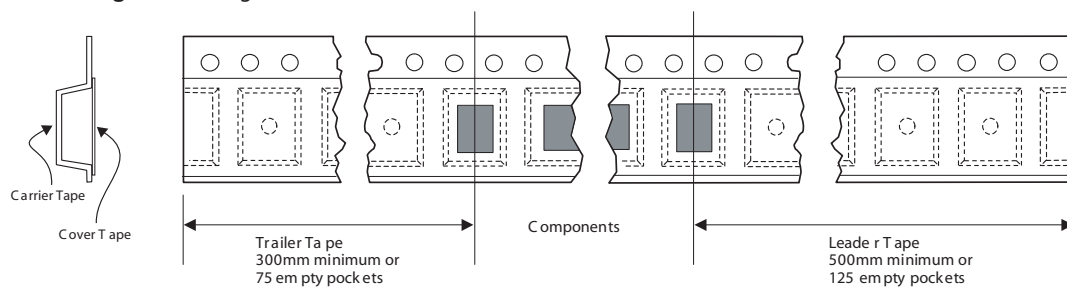
SOT23-3L Unit Orientation



Barcode Label sample

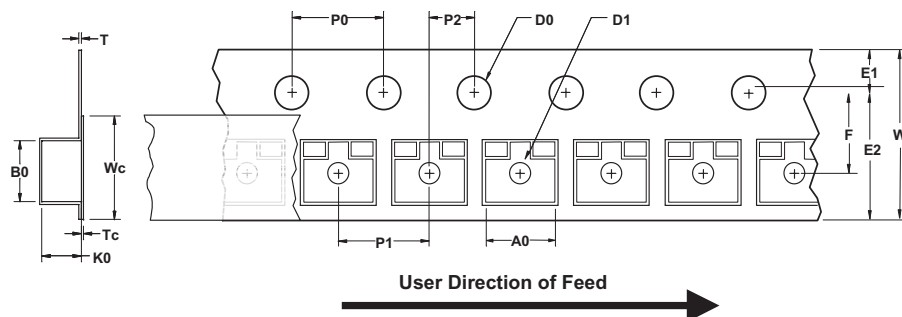
| | |
|-------------------------------------|----------------|
| LOT: CB VK741B 019 | QTY: 3000 |
| FSID: MMSZ5221B | SPEC : |
| D/C1: D9842AB | QTY1: |
| D/C2: QTY2: | SPEC REV: |
| FAIRCHILD SEMICONDUCTOR CORPORATION | CP N: (F63TNR) |

SOT23-3L Tape Leader and Trailer Configuration: Figure 2.0



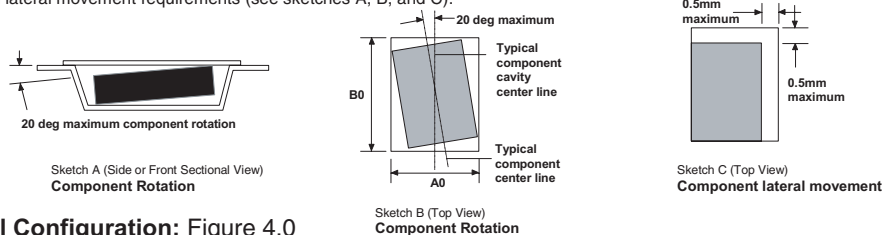
SOT-23 Std Tape and Reel Data, continued

SOT23-3L Embossed Carrier Tape Configuration: Figure 3.0

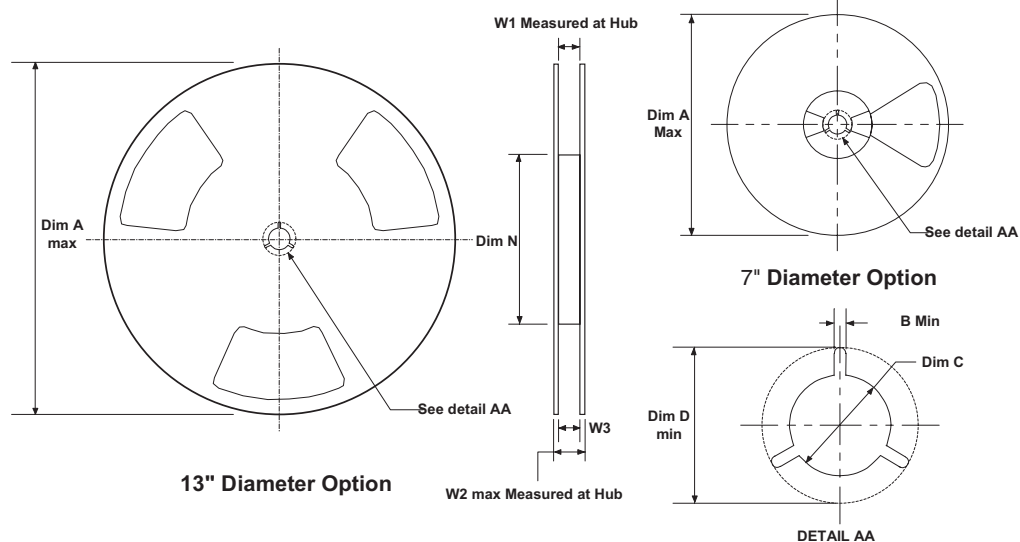


| Dimensions are in millimeter | | | | | | | | | | | | | | |
|------------------------------|-----------------|-----------------|---------------|-----------------|-------------------|-----------------|-------------|-----------------|---------------|---------------|-----------------|-------------------|---------------|-----------------|
| Pkg type | A0 | B0 | W | D0 | D1 | E1 | E2 | F | P1 | P0 | K0 | T | Wc | Tc |
| SOT-23 (8mm) | 3.15 +/-0.10 | 2.77 +/-0.10 | 8.0 +/-0.3 | 1.55 +/-0.05 | 1.125 +/-0.125 | 1.75 +/-0.10 | 6.25 min | 3.50 +/-0.05 | 4.0 +/-0.1 | 4.0 +/-0.1 | 1.30 +/-0.10 | 0.228 +/-0.013 | 5.2 +/-0.3 | 0.06 +/-0.02 |

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



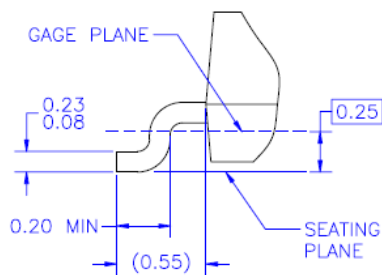
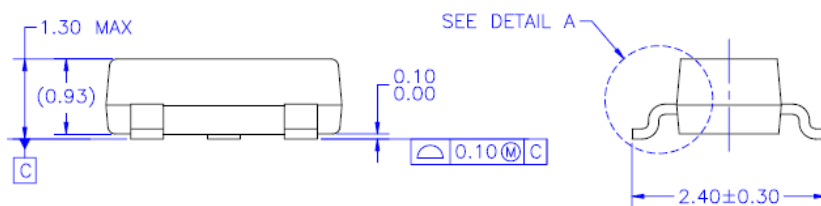
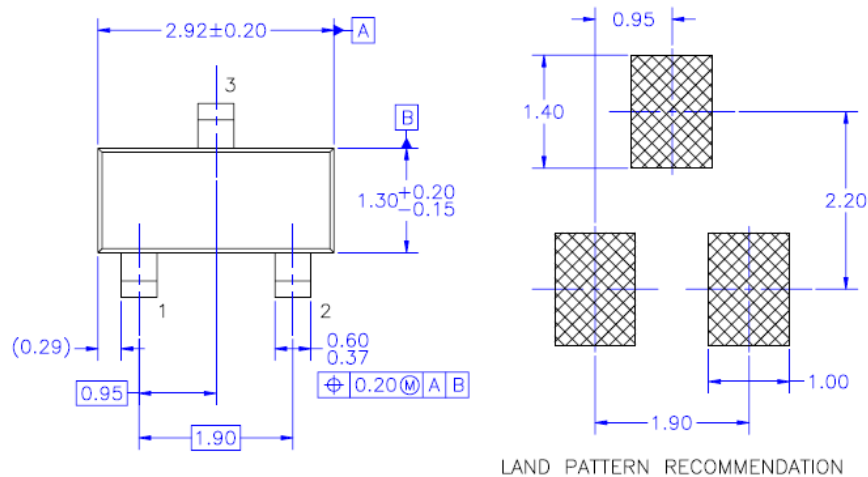
SOT23-3L Reel Configuration: Figure 4.0



| Dimensions are in inches and millimeters | | | | | | | | | |
|--|-------------|---------------|--------------|-----------------------------------|---------------|-------------|-----------------------------------|---------------|-----------------------------|
| Tape Size | Reel Option | Dim A | Dim B | Dim C | Dim D | Dim N | Dim W1 | Dim W2 | Dim W3 (LSL-USL) |
| 8mm | 7" Dia | 7.00 177.8 | 0.059 1.5 | 512 +0.020/-0.008 13 +0.5/-0.2 | 0.795 20.2 | 2.165 55 | 0.331 +0.059/-0.000 8.4 +1.5/0 | 0.567 14.4 | 0.311 - 0.429 7.9 - 10.9 |
| 8mm | 13" Dia | 13.00 330 | 0.059 1.5 | 512 +0.020/-0.008 13 +0.5/-0.2 | 0.795 20.2 | 4.00 100 | 0.331 +0.059/-0.000 8.4 +1.5/0 | 0.567 14.4 | 0.311 - 0.429 7.9 - 10.9 |

Mechanical Dimensions (SOT-23)

SOT-23

DETAIL A
SCALE: 2X

NOTES: UNLESS OTHERWISE SPECIFIED






- A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M — 1994.
- E) DRAWING FILE NAME: MA03DREV9

Dimensions in Millimeters



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

| | | | |
|---|---|---|---|
| AccuPower™ | FRFET® | PowerTrench® | The Power Franchise® |
| Auto-SPM™ | Global Power Resource™ | PowerXS™ | the power® |
| Build it Now™ | Green FPS™ | Programmable Active Droop™ | franchise |
| CorePLUS™ | Green FPS™ e-Series™ | QFET® | TinyBoost™ |
| CorePOWER™ | Gmax™ | QS™ | TinyBuck™ |
| CROSSVOLT™ | GTO™ | Quiet Series™ | TinyCalc™ |
| CTL™ | IntelliMAX™ | RapidConfigure™ | TinyLogic® |
| Current Transfer Logic™ | ISOPLANAR™ |  ™ | TINYOPTO™ |
| DEUXPEED® | MegaBuck™ | Saving our world, 1mW/W/kW at a time™ | TinyPower™ |
| Dual Cool™ | MICROCOUPLER™ | SignalWise™ | TinyPWM™ |
| EcoSPARK® | MicroFET™ | SmartMax™ | TinyWire™ |
| EfficientMax™ | MicroPak™ | SMART START™ | TriFault Detect™ |
|  ™ | MicroPak2™ | SPM® | TRUECURRENT™* |
| Fairchild® | MillerDrive™ | STEALTH™ | µSerDes™ |
| Fairchild Semiconductor® | MotionMax™ | SuperFET™ |  ™ |
| FACT Quiet Series™ | Motion-SPM™ | SuperSOT™-3 | UHC® |
| FACT® | OptoHiT™ | SuperSOT™-6 | Ultra FRFET™ |
| FAST® | OPTOLOGIC® | SuperSOT™-8 | UniFET™ |
| FastvCore™ | OPTOPLANAR® | SupreMOS™ | VCX™ |
| FETBench™ |  ™ | SyncFET™ | VisualMax™ |
| FlashWriter®* | PDP SPM™ | Sync-Lock™ | XS™ |
| FPS™ | Power-SPM™ |  ™ | |
| F-PFS™ | | | |

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|-----------------------|---|
| Advance Information | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. |

Rev. I47

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

[BS170_D26Z](#) [BS170_D27Z](#) [BS170_D75Z](#) [BS170](#) [BS170_J35Z](#)